



AH1902

HIGH SENSITIVITY MICROPOWER OMNIPLOAR HALL-EFFECT SWITCH

Description

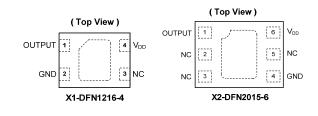
The AH1902 is a high sensitivity micropower Omnipolar Hall effect switch IC with internal pull up and pull down capability. Designed for portable and battery powered consumer equipment such as cellular phones and portable PCs to office equipment, home appliances and industrial applications, the average supply current is only $4.3\mu A$ at 1.8V. To support potable equipment the AH1902 can operate over the supply range of 1.6V to 3.6V and uses a hibernating clocking system to minimize the power consumption. To minimize PCB space the AH1902 is available in small low profile X1-DFN1216-4, X2-DFN2015-6 and SOT553 packages.

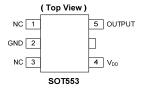
The output is activated with either a north or south pole of sufficient magnetic field strength. When the magnetic flux density (B) perpendicular to the package is larger than operate point (Bop), the output will be turned on (pulled low) and held until B is lower than release point (Brp).

Features

- Omnipolar Operation (North or South Pole)
- Supply Voltage of 1.6V to 3.6V
- High Sensitivity
- Micropower Operation
- Chopper Stabilized Design Provides:
 - Superior Temperature Stability
 - Minimal Switch Point Drift
 - Enhanced Immunity to Physical Stress
- No External Pull-up Resistors Required
- Good RF Noise Immunity
- -40°C to +85°C Operating Temperature
- High ESD capability of 8kV (Human Body Model)
- Small Low Profile X1-DFN1216-4, X2-DFN2015-6 and SOT553 Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments





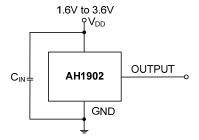
Applications

- Open and Close Detect for flip/slide Cellular Phones
- Smart Cover or Dock Detect for Cellular Phones and Tablet PCs
- Cover or Display Switch in Portable PCs (eg Ultrabook)
- Digital Still, Video Cameras and Handheld Gaming Consoles
- Door, Lids and Tray Position Switches
- Level, Proximity and Position Switches
- Contact-Less Switches in Home Appliances and Industrial Applications

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit



Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 100nF typical and should be placed as close to the supply pin as possible.



Pin Descriptions

Package: X1-DFN1216-4

Pin Number	Pin Name	Function		
1	OUTPUT	Output Pin		
2	GND	Ground Pin		
3	NC	No Connection (Note 5)		
4	V_{DD}	Power Supply Input		
Pad	Pad	The center exposed pad - It is internally connected to V_{DD} pin and should not be connected to GND or any other signal on the PCB. The exposed pad should be left open (unconnected) on the PCB layout.		

Package: X2-DFN2015-6

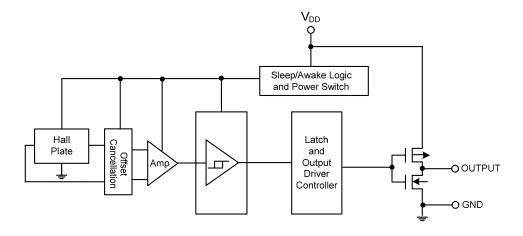
Pin Number	Pin Name	Function		
1	OUTPUT	Output Pin		
2	NC	No Connection (Note 5)		
3	NC	No Connection (Note 5)		
4	GND	Ground Pin		
5	NC	No Connection (Note 5)		
6	V_{DD}	Power Supply Input		
Pad	Pad	The center exposed pad – No connection internally. The exposed pad can be left open (unconnected) or tied to the GND on the PCB layout.		

Package: SOT553

Pin Number	Pin Name	Function		
1	NC	No Connection (Note 5)		
2	GND	Ground Pin		
3	NC	No Connection (Note 5)		
4	V_{DD}	Power Supply Input		
5	OUTPUT	Output Pin		

Note: 5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

Functional Block Diagram





Absolute Maximum Ratings (Note 6) (@T_A = +25°C, unless otherwise specified.)

Symbol		Rating	Unit	
V_{DD}	Supply Voltage (Note 7)	Supply Voltage (Note 7)		
V_{DD_REV}	Reverse Supply Voltage	Reverse Supply Voltage		
loutput	Output current (source and sink)	3	mA	
В	Magnetic Flux Density	Unlimited		
В	Backago Bower Dissipation	X1-DFN1216-4 and X2-DFN2015-6	230	mW
P_{D}	Package Power Dissipation SOT553		230	mW
Ts	Storage Temperature Range	-65 to +150	°C	
TJ	Maximum Junction Temperature	150	°C	
ESD HBM	Human Body Model (HMB) ESD c	apability	8	kV

Notes:

- 6. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
- 7. The absolute maximum V_{DD} of 6V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

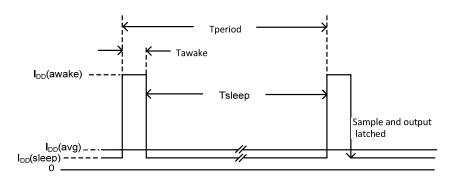
Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	1.6V to 3.6V	V
T _A	Operating Temperature Range	Operating	-40 to +85	°C

Electrical Characteristics (@T_A = +25°C, V_{DD} = 1.8V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OL}	Output Low Voltage (on)	I _{OUT} = 1mA	_	0.1	0.2	V
V _{OH}	Output High Voltage (off)	I _{OUT} = -1mA	V _{DD} -0.2	V _{DD} -0.1	-	V
loff	Output Leakage Current	V _{OUT} = 3.6V, Output off	_	< 0.1	1	μA
I _{DD} (awake)	Connels Courses	During 'awake' period, T _A = +25°C, V _{DD} = 3V	_	2.1	_	mA
I _{DD} (sleep)	Supply Current	During 'sleep' period, T _A = +25°C, V _{DD} = 3V	_	2.5	_	μΑ
1 (2.12)	Average Supply Current	T _A = +25°C, V _{DD} = 1.8V	_	4.3	8	μA
I _{DD} (avg)	Average Supply Current	T _A = +25°C, V _{DD} = 3.6V	_	7.2	13	μA
Tawake	Awake Time	(Note 8)	_	50	100	μs
Tperiod	Period	(Note 8)	_	50	100	ms
D.C.	Duty Cycle	_	_	0.1		%

Note: 8. When power is initially turned on, the operating V_{DD} (1.6V to 3.6V) must be applied to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 100ms).



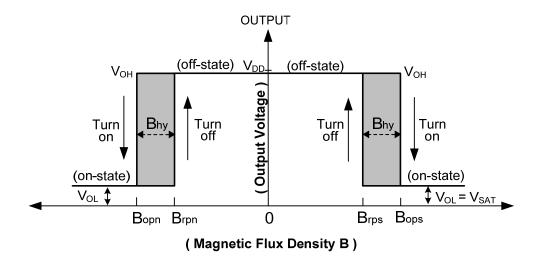


Magnetic Characteristics (Note 9 &10) (T_A = +25°C, V_{DD} = 1.8V, unless otherwise specified)

					(1mT=10 (Gauss)
Symbol	Characteristics	Test Condition	Min	Тур	Max	Unit
		_	23	33	47	
Bops (south pole to part marking side)		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	21	33	48	
	Operation Point	_	-47	-33	-24	
Bopn (north pole to part marking side)		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	-48	-33	-21	
		_	12	23	35	Gauss
Brps (south pole to part marking side)		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	9	23	38	
	Release Point	_	-35	-23	-12	
Brpn (north pole to part marking side)		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	-38	-23	-9	
Bhy (Bopx - Brpx)	Hysteresis	_	_	10	_	

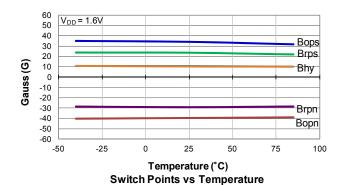
Notes:

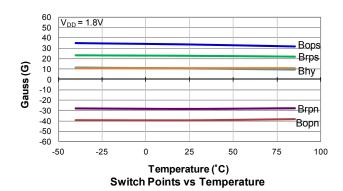
- 9. Typical data is at T_A = +25°C, V_{DD} = 1.8V.
- Maximum and minimum parameters values over operating temperature range are not tested in production, they are guaranteed by design, characterization and process control. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

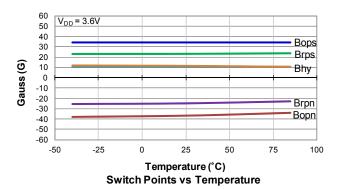


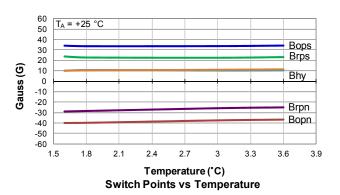


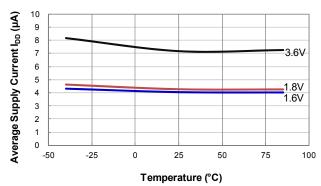
Typical Operating Characteristics

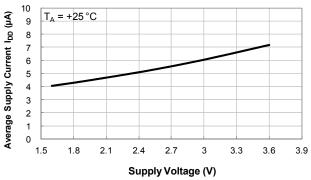










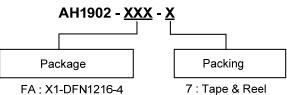


Average Supply Current vs. Temperature

Average Supply Current vs. Supply Voltage



Ordering Information



FT4: X2-DFN2015-6 Z:SOT553

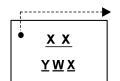
7: Tape & Reel

Part Number	Package	Pookaging	7" Tape a	and Reel
Part Number	Code	Packaging	Quantity	Part Number Suffix
AH1902-FA-7	FA	X1-DFN1216-4	3000/Tape & Reel	-7
AH1902-FT4-7	FT4	X2-DFN2015-6	3000/Tape & Reel	-7
AH1902-Z-7	Z	SOT553	3000/Tape & Reel	-7

Marking Information

(1) Package Type: X1-DFN1216-4 and X2-DFN2015-6

(Top View)



Pin 1 indicator

 \underline{XX} : Identification Code \underline{Y} : Year: 0~9

W: Week: A~Z: 1~26 week;

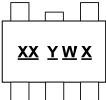
a~z: 27~52 week; z represents

52 and 53 week \underline{X} : Internal code

Part Number	Package	Identification Code	
AH1902-FA-7	X1-DFN1216-4	F2	
AH1902-FT4-7	X2-DFN2015-6	D2	

(2) Package Type: SOT553

(Top View)



 $\frac{XX}{Y}: \mbox{Identification Code} \\ \frac{Y}{Y}: \mbox{Year}: 0 \mbox{ to } 9$

W: Week: A to Z: 1~26 week; a to z: 27~52 week; z represents 52 and 53 week

X: Internal code

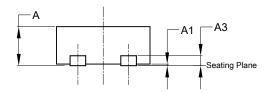
Part Number	Package	Identification Code
AH1902-Z-7	SOT553	D2

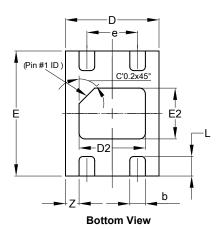


Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

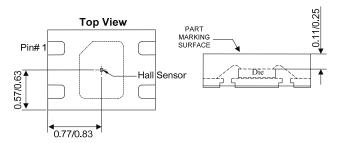
(1) Package Type: X1-DFN1216-4





	X1-DFN1216-4						
Dim	Min	Max	Тур				
Α	0.47	0.53	0.50				
A1	0.00	0.05	0.02				
A3			0.13				
b	0.15	0.25	0.20				
D	1.15	1.25	1.20				
D2	0.75	0.95	0.85				
Е	1.55	1.65	1.60				
E2	0.55	0.75	0.65				
е	-	-	0.65				
L	0.20	0.30	0.25				
Z	-	-	0.175				
All D	imens	ions in	mm				





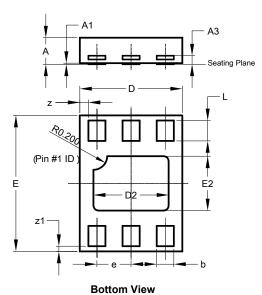
Sensor Location



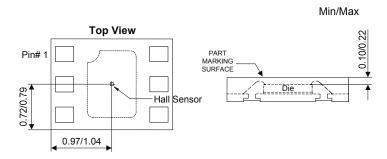
Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

(2) Package Type: X2-DFN2015-6



)	X2-DFN2015-6							
Dim	Min	Max	Тур					
Α	0.375	0.40	0.390					
A1	0	0.05	0.02					
А3	-	ı	0.13					
b	0.20	0.30	0.25					
D	1.45	1.575	1.50					
D2	1.00	1.20	1.10					
е	-	ı	0.50					
Е	1.95	2.075	2.00					
E2	0.70	0.90	0.80					
L	0.25	0.35	0.30					
Z	-	-	0.125					
Z1	-	-	0.075					
All D	imens	ions ii	n mm					

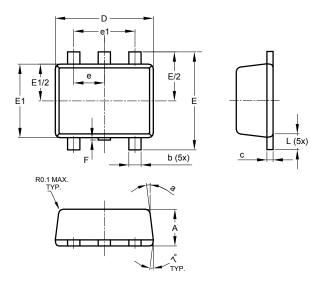


Sensor Location

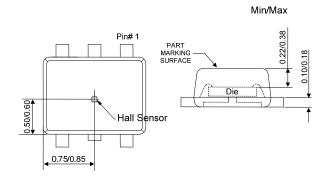


Package Outline Dimensions (cont.) (All dimensions in mm.)

(3) Package Type: SOT553



SOT553				
Dim	Min	Max	Тур	
Α	0.55	0.62	0.60	
b	0.15	0.30	0.20	
С	0.10	0.18	0.15	
D	1.50	1.70	1.60	
Е	1.55	1.70	1.60	
E1	1.10	1.25	1.20	
е	0.50 BSC			
e1	1.00 BSC			
F	0.00	0.10	_	
L	0.10	0.30	0.20	
а	6°	8°	7°	
All Dimensions in mm				



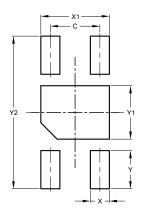
Sensor Location



Suggested Pad Layout

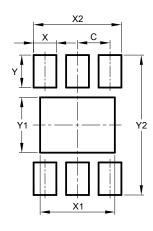
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

(1) Package Type: X1-DFN1216-4



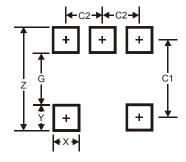
X1-DFN1216-4			
Dimensions	Value		
С	0.65		
Х	0.25		
X1	0.90		
Y	0.50		
Y1	0.70		
Y2	2.00		
All Dimensions in mm			

(2) Package Type: X2-DFN2015-6



X2-DFN2015-6			
Dimensions	Value		
С	0.500		
Х	0.350		
X1	1.150		
X2	1.350		
Y	0.500		
Y1	0.850		
Y2	2.150		
All Dimensions in mm			

(3) Package Type: SOT553



SOT553		
Dimensions	Value	
Z	2.2	
G	1.2	
Х	0.375	
Υ	0.5	
C1	1.7	
C2	0.5	
All Dimensions in mm		



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